

FDP8878

N-Channel Logic Level PowerTrench[®] MOSFET 30V, 40A, 15m Ω

General Descriptions

This N-Channel MOSFET has been designed specifically to improve the overall efficiency of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized for low gate charge, low $r_{\text{DS}(\text{ON})}$ and fast switching speed.

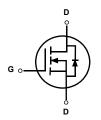
Features

- $r_{DS(ON)} = 15mΩ$, $V_{GS} = 10V$, $I_D = 40A$
- $r_{DS(ON)} = 19m\Omega$, $V_{GS} = 4.5V$, $I_D = 36A$
- High performance trench technology for extremely low rds(ON)
- Low gate charge
- High power and current handling capability
- RoHS Compliant









MOSFET Maximum Ratings T_A = 25°C unless otherwise noted

Symbol	Parameter	Ratings	Units		
V_{DSS}	Drain to Source Voltage	30	V		
V_{GS}	Gate to Source Voltage	±20	V		
I _D	Drain Current				
	Continuous ($T_C = 25^{\circ}C$, $V_{GS} = 10V$)	40	Α		
	Continuous ($T_C = 25^{\circ}C$, $V_{GS} = 4.5V$)	36	Α		
	Pulsed	(Note 4)	141	Α	
E _{AS}	Single Pulse Avalanche Energy (Note 1)	L = 1mH, I _{AS} = 11A	60	mJ	
		$L = 43\mu H, I_{AS} = 32A$	22	7 1113	
P _D	Power dissipation	40.5	W		
T _J , T _{STG}	Operating and Storage Temperature	-55 to 175	°C		

Thermal Characteristics

$R_{\theta JC}$	Thermal Resistance, Junction to Case (Note 2)	3.7	°C/W
$R_{\theta,JA}$	Thermal Resistance, Junction to Ambient at 1000 seconds (Note 3)	43	°C/W

Package Marking and Ordering Information

Device Marking Device		Package	Package Reel Size		Quantity
FDP8878	FDP8878	TO-220	Tube	n/a	45 units

						Units
acteristics						
Drain to Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$		30	-	-	V
Breakdown Voltage Temp. Coefficient	$I_D = 250 \mu A$, Referenced to 25°C			21		mV/°C
Zero Gate Voltage Drain Current	$V_{DS} = 24V$ $V_{DS} = 0V$ $T_{A} = 0$	150°C	-	-	1 250	μΑ
Gate to Source Leakage Current		.00 0	-	-	±100	nA
actoristics					l	1
	Vcs = Vps. Ip = 250µA		1.2	1.7	2.5	V
Gate to Source Threshold Voltage	$I_D = 250 \mu A$,					
Temperature Coefficient	Referenced to 25°C			-5		mV/ºC
	$I_D = 40A, V_{GS} = 10V$		-	12	15	
Drain to Source On Resistance	$I_D = 36A, V_{GS} = 4.5V$	-	16	19	mΩ	
Brain to Goarde On Negotianide	I _D = 40, V _{GS} = 10V, T _A = 175°C		-	20	25	11152
Characteristics						
Input Capacitance	V _{DS} = 15V, V _{GS} = 0V,		-	927	1235	pF
Output Capacitance			-	188	250	pF
Reverse Transfer Capacitance			-	1130	175	pF
Gate Resistance	f = 1MHz			3.0		Ω
Total Gate Charge at 10V	$V_{GS} = 0V \text{ to } 10V V_{DD} =$	= 15V	-	17.1	23	nC
Total Gate Charge at 5V			-	9.2	12	nC
-			-	2.6	-	nC
Gate Charge Threshold to Plateau	1	-	-	1.7	-	nC
Gate to Drain "Miller" Charge			-	3.7	-	nC
g Characteristics (V _{GS} = 10V)						
Turn-On Time			-	255	383	ns
	$V_{DD} = 15V, I_{D} = 40A$ $V_{GS} = 10V, R_{GS} = 16\Omega$		_	11.1		ns
			_	244		ns
			-	14.8		ns
· · · · · · · · · · · · · · · · · · ·			-	35.3		ns
Turn-Off Time			-	50	75	ns
urce Diode Characteristics	-	<u> </u>				
	I _{SD} = 40A		-	1.1	1.25	V
Source to Drain Diode voltage	I _{SD} = 3.2A		-	0.85	1.2	V
Reverse Recovery Time		A/μs	-	14.4	18.8	ns
Reverse Recovered Charge	I _{SD} = 40A, dI _{SD} /dt=100A/μs		-	5.1	6.7	nC
	Zero Gate Voltage Drain Current Gate to Source Leakage Current Gate to Source Threshold Voltage Gate to Source Threshold Voltage Temperature Coefficient Drain to Source On Resistance Characteristics Input Capacitance Output Capacitance Gate Resistance Total Gate Charge at 10V Total Gate Charge at 5V Gate to Source Gate Charge Gate to Drain "Miller" Charge Gate to Drain "Miller" Charge g Characteristics (V _{GS} = 10V) Turn-On Time Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Turn-Off Time urce Diode Characteristics Source to Drain Diode Voltage Reverse Recovery Time	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	

Notes:
 Starting T_J = 25°C, V_{DD} = 30V, V_{GS} = 10V
 R_{θJA} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{θJA} is guaranteed by design while R_{θJA} is determined by the user's board design.
 R_{θJA} is measured with 1.0 in² copper on FR-4 board
 Pulse Test: Pulse Width < 300µs, Duty Cycle < 2.0%



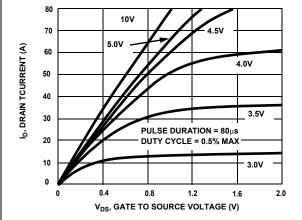


Figure 1. On Region Characteristics

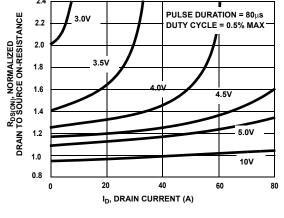


Figure 2. On-Resistance Variation with Drain Current and Gate Voltage

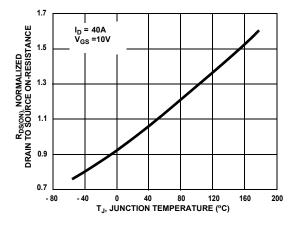


Figure 3. On Resistance Variation with Temperature

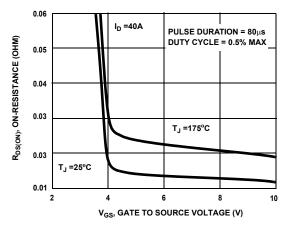


Figure 4. On-Resistance Variation with Gate-to-Source Votlage

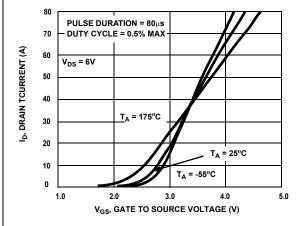


Figure 5. Transfer Characteristics

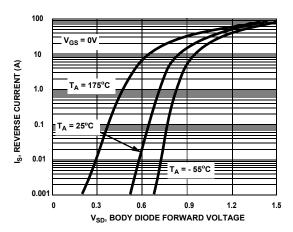


Figure 6. Body Diode Forward Voltage Variation With Source Current and Temperature

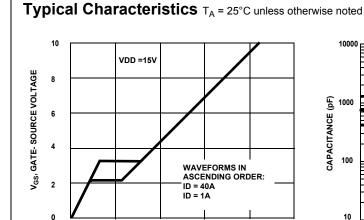


Figure 7. Gate Charge Characteristics

12

Q_q, GATE CHARGE (nC)

16

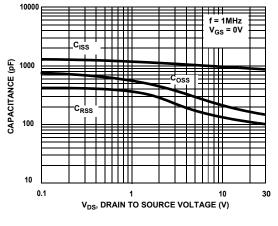


Figure 8. Capacitance Characteristics

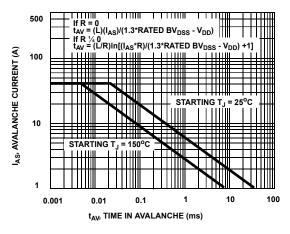


Figure 9. Unclamped Inductive Switching Capability

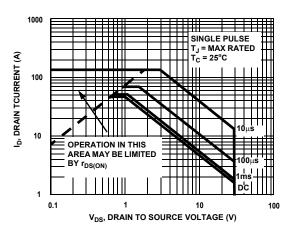


Figure 10. Safe Operating Area

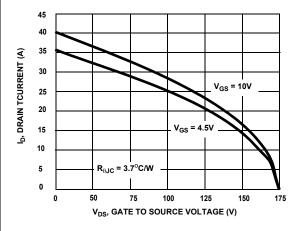


Figure 11. Maximum Continuous Drain Current vs Case Temperature

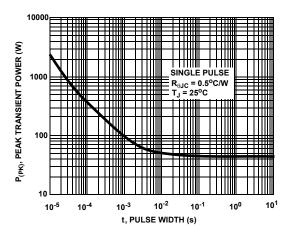


Figure 12. Single Pulse Maximum Power Dissipation

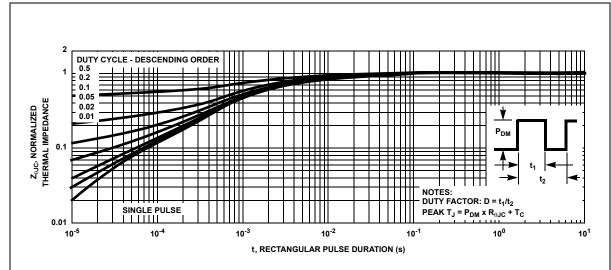


Figure 13. Transient Thermal Response Curve

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